

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc695isw-3.3#pbf

(Engineering Calculation)

SOIC WIDE

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**TOTAL MASS (g) : 0.248448**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.003849	1000000	15492.1533203		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.138021	975000	555532		
		Iron (Fe)	7439-89-6	0.003397	24000	13672.8613281		
		Phosphorus (P)	7723-14-0	0.000042	300	169.049224854		
		Zinc (Zn)	7440-66-6	0.000099	700	398.473144531		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.141559</b>	<b>1000000</b>	<b>569772.375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.004771	1000000	19204.6660156		
		<b>External Plating Total:</b>				<b>0.004771</b>	<b>1000000</b>	<b>19204.6660156</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001132	1000000	4556.27880859		
<b>Internal Plating Total:</b>				<b>0.001132</b>	<b>1000000</b>	<b>4556.27880859</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001075	750000	4326.85546875		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000358	250000	1440.94335938		
<b>Die Attach Total:</b>				<b>0.001433</b>	<b>1000000</b>	<b>5767.79785156</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.009816	103000	39509.21875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.085294	895000	343306.75		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000191	2000	768.77142334		
		<b>Encapsulation Total:</b>				<b>0.095301</b>	<b>1000000</b>	<b>383584.78125</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000403	1000000	1622.06750488		
					<b>TOTAL MASS (g) :</b>	<b>0.248448</b>		